MOSFET Module

MOSFET

STARPOWER

SEMICONDUCTOR

MD100HFC120C2S

1200V/100A 2 in one-package

General Description

STARPOWER MOSFET Power Module provides very low $R_{DS(on)}$ as well as optimized intrinsic diode. It's designed for the applications such SMPS and DC drives.

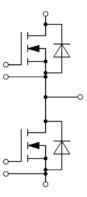
Features

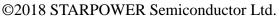
- SiC power MOSFET
- Low R_{DS(on)}
- Optimized intrinsic reverse diode
- Chip sintering technology
- Low inductance case avoid oscillations
- Isolated copper baseplate using DBC technology

Typical Applications

- Main and auxiliary AC drives of electric vehicles
- DC servo and robot drives
- Battery vehicles
- UPS equipment
- Plasma cutting

Equivalent Circuit Schematic





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Absolute Maximum Ratings

MOSFET

Symbol	Description	Value	Unit	
V _{DSS}	Drain-Source Voltage	1200	V	
V _{GSS}	Gate-Source Voltage	-5/+20	V	
I _D	Drain Current @ T _C =25°C	155		
	@ $T_{C}=110^{\circ}C$	100	A	
I _{DM}	Pulsed Drain Current	500	Α	
P _D	Maximum Power Dissipation @ T _i =175°C	585	W	

DIODE

Symbol	Description	Value	Unit
I _F	Diode Continuous Forward Current	100	Α

Module

Symbol	Description	Value	Unit
T _{jmax}	Maximum Junction Temperature	175	°C
T _{jop}	Operating Junction Temperature	-40 to +150	°C
T _{STG}	Storage Temperature Range	-40 to +150	°C
V _{ISO}	Isolation Voltage RMS,f=50Hz,t=1min	4000	V

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
R _{DS(on)}	Static Drain-Source On-Resistance	$I_{D}=100A, V_{GS}=20V, T_{j}=25^{\circ}C$		12.5	17.0	mΩ
		$I_{D}=100A, V_{GS}=20V, T_{j}=150^{\circ}C$		21.5		
$V_{GS(th)}$	Gate-Source Threshold Voltage	$I_{D}=25\text{mA}, V_{DS}=V_{GS},$ $T_{j}=25^{\circ}\text{C}$	2.4	3.0		V
$g_{\rm fs}$	Forward Transconductance	V _{DS} =20V,I _D =100A		47.2		S
I _{DSS}	Drain-Source Leakage Current	$V_{DS}=V_{DSS}, V_{GS}=0V,$ $T_j=25^{\circ}C$			200	μΑ
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=V_{GSS}, V_{DS}=0V,$ $T_j=25^{\circ}C$			1.2	μΑ
C _{iss}	Input Capacitance			5.57		nF
Coss	Output Capacitance	$V_{GS}=0V, V_{DS}=1000V,$		0.44		nF
C _{rss}	Reverse Transfer Capacitance	f=1MHz		0.03		nF
Qg	Total Gate Charge			322		nC
Q_{gs}	Gate-Source Charge	$I_D = 100A, V_{DS} = 800V,$		92		nC
Q_{gd}	Gate-Drain ("Miller") Charge	V _{GS} =-5/20V		100		nC
t _{d(on)}	Turn-On Delay Time			14		ns
t _r	Rise Time	V_{DS} =800V, I_D =100A,		32		ns
t _{d(off)}	Turn-Off Delay Time	$R_{G}=1.3\Omega, V_{GS}=-5/20V,$ $T_{j}=25^{\circ}C$		29		ns
t _f	Fall Time			28		ns
Eon	Turn-On Switching Loss	$V_{DS} = 800 V, I_D = 100 A,$		2.8		mJ
E_{off}	Turn-Off Switching Loss	$R_{G}=1.3\Omega, V_{GS}=-5/20V, T_{j}=25^{\circ}C$		0.6		mJ

MOSFET Characteristics

DIODE Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
$V_{\rm F}$	Diode Forward	$I_{\rm F}=100{\rm A}, V_{\rm GS}=0{\rm V}, T_{\rm j}=25^{\rm o}{\rm C}$		1.60	1.80	V
	Voltage	$I_{\rm F}=100{\rm A}, V_{\rm GS}=0{\rm V}, T_{\rm j}=150^{\rm o}{\rm C}$		2.25	2.70	v
Q _C	Total Capacitive Charge	V _R =800V,T _j =25°C		492		nC

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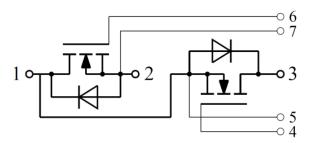
Symbol	Parameter		Тур.	Max.	Unit
р	Junction-to-Case(per MOSFET)			0.256	K/W
R_{thJC}	Junction-to-Case(per DIODE)			0.295	K/ W
	Case-to-Heatsink (per MOSFET)		0.037		
$R_{\rm thCH}$	Case-to-Heatsink (per DIODE)		0.043		K/W
	Case-to-Heatsink (per Module)		0.010		
м	Terminal Connection Torque, Screw M6	2.5		5.0	N.m
М	Mounting Torque, Screw M6	3.0		5.0	IN.III
G	Weight of Module		300		g

Module Characteristics $T_C=25^{\circ}C$ unless otherwise noted

MD100HFC120C2S

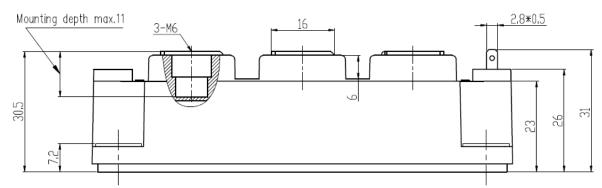
MOSFET Module

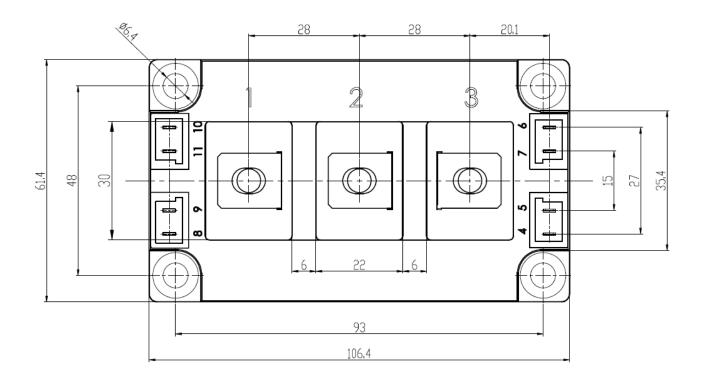
Circuit Schematic



Package Dimensions

Dimensions in Millimeters





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